AMENDMENTS TO THE CLAIMS

The following Listing of Claims will replace all prior versions, and listings, of

claims in the application:

Listing of Claims:

Claim 1 (withdrawn): A copper alloy for welding electrodes, wherein the

copper alloy contains as second element, which does not dissolve or scarcely

dissolves in copper in a solid solution state at room temperature, said second

element being selected from the group consisting of chromium (Cr), zirconium (Zr),

beryllium (Be), titanium (Ti) and boron (B), respective addition ratios of the second

element being Cr: 0.1 to 1.4 wt%, Zr: 0.15 to 0.5 wt%, Be: 0.1 to 3.0 wt%, Ti: 0.1 to

6.0 wt%, B: 0.01 to 0.5 wt%, and wherein the alloy has an average crystal grain size

of not more than 20 μ m, the second element precipitates among crystal grains, and

the copper alloy has a hardness of not less than 30 HRB, an electrical conductivity

of not less than 85 IACS%, and a thermal conductivity of not less than 350 W/(m·K).

Claims 2-4 (cancelled)

Claim 5 (previously presented): A method of manufacturing a copper alloy for

welding electrodes, comprising the steps of:

enabling any of chromium (Cr), zirconium (Zr), beryllium (Be), titanium (Ti) and boron

(B) to dissolve in a solid solution in a base-material metal (Cu) as a second element

that does not dissolve or scarcely dissolves in copper in a solid solution state at

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room temperature, wherein respective addition ratios of the second element being Cr: 0.1 to 1.4 wt%, Zr: 0.15 to 0.5 wt%, Be: 0.1 to 3.0 wt%, Ti: 0.1 to 6.0 wt%, B:

0.01 to 0.5 wt%,

applying a strain equivalent to an elongation of not less than 200% to this material to

achieve crystal grain refinement, and

subjecting this material to aging treatment simultaneously with or subsequent to

application of this strain, thereby promoting precipitation of the second element

among crystal grains.

Claim 6 (cancelled)

Claim 7 (previously presented): The method of manufacturing a copper alloy

for welding electrodes according to claim 5, strain is applied to the material by any of

extruding, drawing, shearing, rolling and forging.

Claim 8 (previously presented): The method of manufacturing a copper alloy

for welding electrodes according to claim 7, wherein strain is applied by extruding

the material, and extrusion conditions are such that lateral extrusion is performed at

a material temperature of 400 to 1,000°C, a die temperature of 400 to 500°C, and an

extrusion speed of 0.5 to 2.0 mm/sec.

Claim 9 (previously presented): The method of manufacturing a copper alloy

for welding electrodes according to claim 5, wherein the material is subjected to

aging treatment before a strain is applied to the material.

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Claim 10 (withdrawn): A composite copper material for welding electrodes, wherein an alumina powder or a titanium boride powder is dispersed in a copper matrix in an amount of 0.1 to 5.0 wt%, said composite copper material has a hardness of at least 30 HRB, an electrical conductivity of at least 85 IACS%, and a thermal conductivity of at least 350 W/(m·K).

Claims 11-13 (cancelled)

Claim 14 (withdrawn): A method of manufacturing a composite copper material, comprising the steps of:

mixing a copper powder and a ceramic powder together to forming a mixed powder as a primary shaped body, and

applying a strain to said primary shaped body to form a secondary shaped body in which base material and ceramic particles are combined together with refined particle sizes,

wherein an average particle size of the ceramic powder is between about 0.3 to 10 μm, the strain applied to the primary shaped body is equivalent to an elongation of not less than 200%, the strain is applied by extruding the primary shaped body that is performed at a material temperature of not less than 400°C but not more than 1,000°C and a die temperature of not less than 400°C but not more than 500°C, wherein an average particle size of a base material of the secondary shaped body to be obtained is not more than 20 µm, and the average particle size of ceramic particles is not more than 500 nm.

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Claim 15 (cancelled)

Claim 16 (withdrawn): The method of manufacturing a composite copper

material according to claim 14, wherein the primary shaped body is obtained by

green compacting or by filling the mixed powder in a tube.

Claim 17 (cancelled)

Claim 18 (withdrawn): A method of manufacturing a composite copper

material in which titanium boride is dispersed in a copper matrix, comprising the

steps [1] to [3] of:

[1] mixing a copper powder, a titanium powder and a boron powder together

to form a primary shaped body;

[2] applying thermal energy to the primary shaped body and thereby causing

the titanium powder and the boron powder to react with each other in order to form

titanium boride in the copper matrix; and

[3] applying a strain to the primary shaped body, in which the titanium boride

is formed, by plastically deforming the primary shaped body and thereby forming a

secondary shaped body.

Claim 19 (withdrawn): The method of manufacturing a composite copper

material according to claim 18, wherein the secondary shaped body is subjected to

heat treatment while applying the strain by plastic deformation or following

application of the strain.

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Claim 20 (withdrawn): The method of manufacturing a composite copper

material according to claim 18, wherein plastic deformation involves applying a strain

equivalent to an elongation of not less than 200%.

Claim 21 (withdrawn): The method of manufacturing a composite copper

material according to claim 18, wherein the plastic deformation is extrusion that is

performed at a material temperature of not less than 400°C but not more than

1000°C.

Claim 22 (withdrawn): The method of manufacturing a composite copper

material according to claim 18, wherein the plastic deformation is extrusion that is

performed at a die temperature of not less than 400°C but not more than 500°C.

Claim 23 (withdrawn): The method of manufacturing a composite copper

material according to claim 18, wherein the primary shaped body is obtained by

green compacting or by filling a mixed powder in a tube.

Claim 24 (withdrawn): The method of manufacturing a composite copper

material according to claim 18, wherein an average particle size of the ceramic

powder is 0.3 to 10 µm, an average particle size of a base material of the secondary

shaped body to be obtained is not more than 20µm, and an average particle size of

titanium boride particles is not more than 500 nm.

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